



#### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

VDSS	RDS(ON) Max	I <sub>D Max</sub> T <sub>A</sub> = +25°C
-8V	$5.7$ m $\Omega$ @V <sub>GS</sub> = -4.5V	-13.2A

## **Description**

This  $3^{rd}$  generation Lateral MOSFET (LD-MOS) is engineered to minimize on-state losses and switch ultra-fast, making it ideal for high efficiency power transfer. It uses Chip-Scale Package (CSP) to increase power density by combining low thermal impedance with minimal  $R_{DS(ON)}$  per footprint area.

## **Applications**

- DC-DC Converters
- Battery Management
- Load Switch

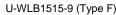
# ESD PROTECTED

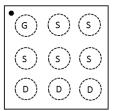
#### **Features**

- LD-MOS Technology with the Lowest Figure of Merit:
- R<sub>DS(ON)</sub> = 5.7mΩ to Minimize On-State Losses
- Q<sub>g</sub> = 8.2nC for Ultra-Fast Switching
- V<sub>GS(TH)</sub> = -0.6V Typ. for a Low Turn-On Potential
- CSP with Footprint 1.5mm × 1.5mm
- Height = 0.60mm for Low Profile
- ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

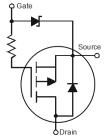
#### **Mechanical Data**

- Case: U-WLB1515-9
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal: Finish SnAgCu. Solderable per MIL-STD-202 Method 208 (e1)
- UBM Size: 245µm
- Terminal Connections: See Diagram Below
- Weight: 0.0018 grams (Approximate)





Top-View Pin Configuration



**Equivalent Circuit** 

## **Ordering Information** (Note 4)

Ī	Part Number	Case	Packaging
	DMP1008UCB9-7	U-WLB1515-9 (Type F)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

U-WLB1515-9 (Type F)



 $\begin{array}{l} YY = Product\ Type\ Marking\ Code \\ YM = Date\ Code\ Marking \\ Y\ or\ \overline{Y} = Year\ (ex:\ G=2019) \\ M\ or\ \overline{M} = Month\ (ex:\ 9=September) \end{array}$ 

Date Code Key

Date Code Ney												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н	- 1	J	K	L	M	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			VDSS	-8	V
Gate-Source Voltage			V <sub>GSS</sub>	-6	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lD	-9.8 -7.8	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	lD	-13.2 -10.5	А		
Pulsed Drain Current (Pulse Duration 10µs, Duty	Cycle ≤1%	I <sub>DM</sub>	-80	Α	
Continuous Source Pin Current (Note 6)		Is	-1.8	Α	
Pulsed Source Pin Current (Pulse Duration 10µs,	Duty Cycle	I <sub>SM</sub>	-80	A	
Continuous Gate Current	•	lg	-0.8	Α	

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	0.84	W
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.53	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	151.4	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	82	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

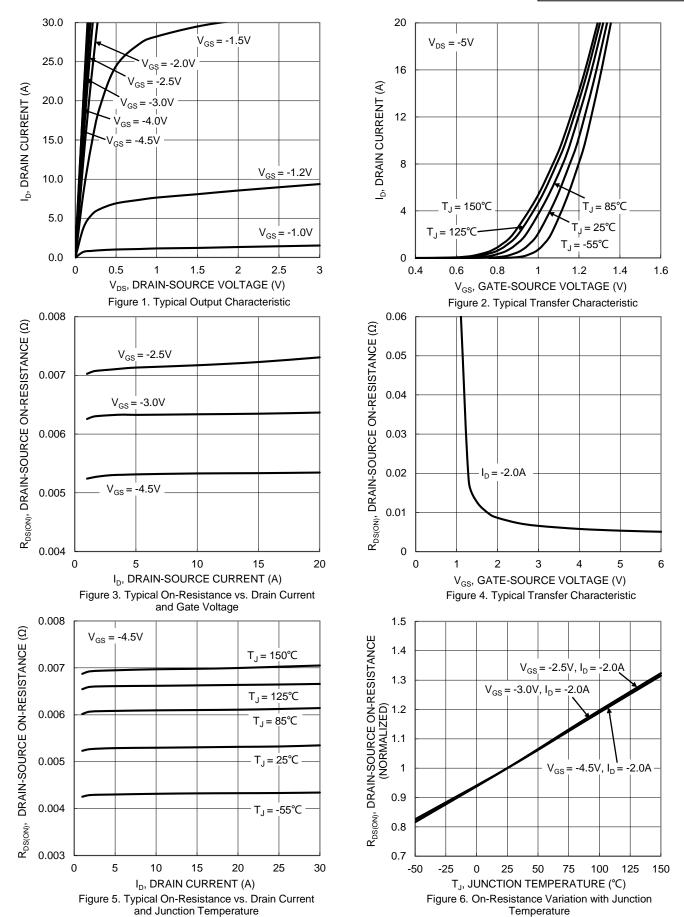
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-8	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	_	_	-1	μΑ	V <sub>DS</sub> = -6.4V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	-100	nA	V <sub>G</sub> S = -6.0V, V <sub>D</sub> S = 0V	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.4	-0.6	-1.1	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
			4.7	5.7		$V_{GS} = -4.5V$ , $I_{D} = -2A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	6.3	8.2	mΩ	$V_{GS} = -3.0V, I_{D} = -2A$	
			6.8	9.1		$V_{GS} = -2.5V, I_{D} = -2A$	
Diode Forward Voltage (Note 6)	$V_{SD}$	_	-0.63	-1	V	$V_{GS} = 0V$ , $I_S = -2A$	
Reverse Recovery Charge	Q <sub>RR</sub>	_	9.2	_	nC	V <sub>DD</sub> = -5V, I <sub>F</sub> = -2A,	
Reverse Recovery Time	trr	_	25	_	ns	di/dt = 200A/μs	
DYNAMIC CHARACTERISTICS (Note 8)	•					•	
Input Capacitance	Ciss	_	900	_	pF	.,	
Output Capacitance	Coss	_	730	-	pF	$V_{DS} = -4V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	158	_	pF	T = 1.0WHZ	
Series Gate Resistance	Rg	_	21.4	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1.0MHz$	
Total Gate Charge	Qg	_	8.2	_	nC	4.514.14	
Gate-Source Charge	Qgs	_	0.9	_	nC	Vgs = -4.5V, Vps = -4V,	
Gate-Drain Charge	Qgd	_	1.0	_	nC	I <sub>D</sub> = -2A	
Turn-On Delay Time	td(ON)	_	20.0	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	5.8	_	ns	V <sub>DD</sub> = -4V, V <sub>GS</sub> = -4.5V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	99.6	_	ns	$I_{DS} = -2A$ , $R_G = 10\Omega$	
Turn-Off Fall Time	tF	_	36.4	_	ns	7	

Notes:

- Device mounted on FR-4 PCB with minimum recommended pad layout.
  Device mounted on FR-4 material with 1-inch² (6.45cm²), 2oz (0.071mm thick) Cu.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.







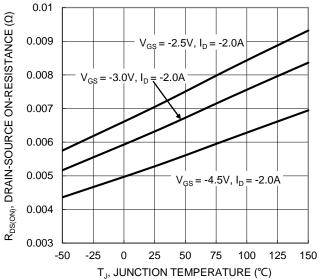
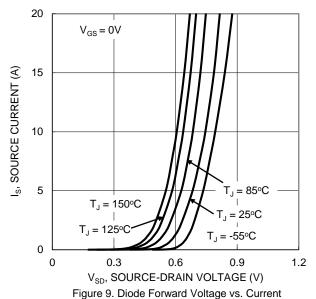


Figure 7. On-Resistance Variation with Junction Temperature



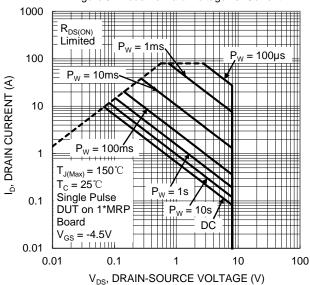


Figure 11. SOA, Safe Operation Area

0.9  $V_{GS(TH)},\; GATE\; THRESHOLD\; VOLTAGE\; (V)$ 0.8 0.7  $I_D = -1mA$ 0.6 0.5  $I_D = -250 \mu A$ 0.4 0.3 0.2 -50 -25 0 25 50 75 100 125 150 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature

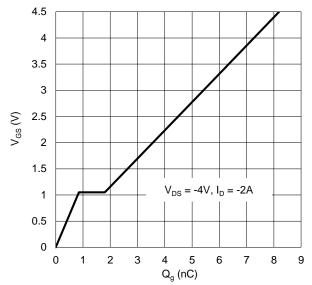


Figure 10. Gate Charge



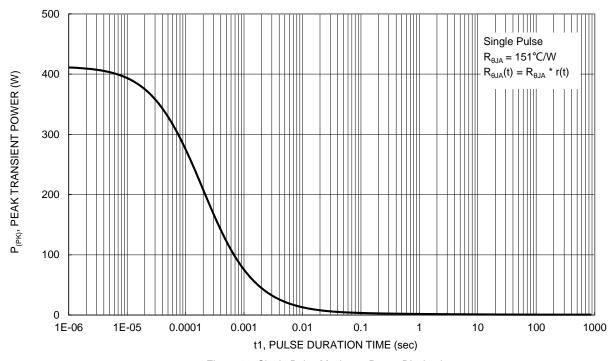


Figure 12. Single Pulse Maximum Power Dissipation

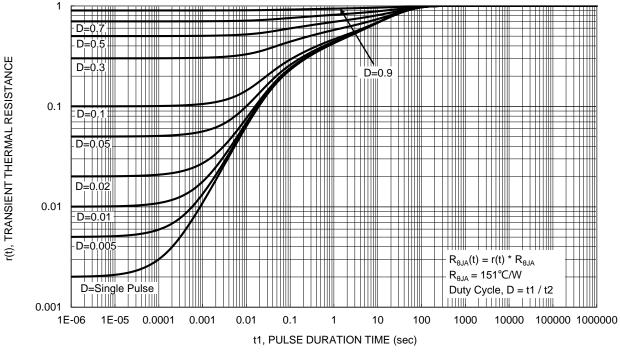


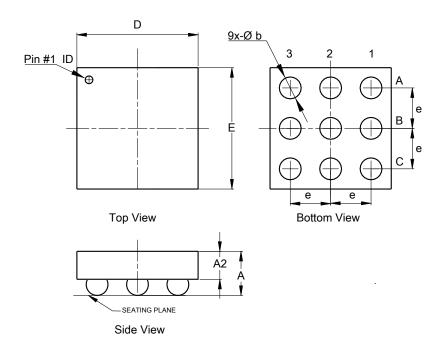
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-WLB1515-9 (Type F)

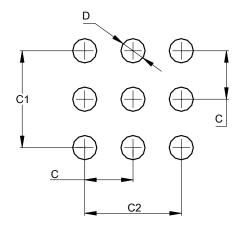


U-WLB1515-9 (Type F)								
Dim Min Max Typ								
Α		0.60						
A2	0.31	0.36	0.335					
b	0.220	0.320	0.270					
D	1.48	1.53	1.505					
<b>E</b> 1.48 1.53 1.50								
<b>e</b> 0.50								
All Dimensions in mm								

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-WLB1515-9 (Type F)



Dimensions	Value (in mm)
С	0.50
C1	1.00
C2	1.00
D	0.25



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